



A Product Line of Diodes Incorporated



BCX6825

20V NPN SILICON PLANAR MEDIUM POWER TRANSISTOR IN SOT89

Features

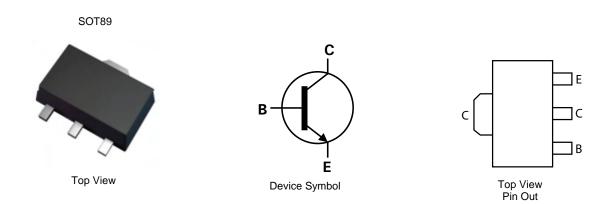
- BV_{CEO} > 20V
- I_C = 1A high Continuous Current
- Low saturation voltage V_{CE(sat)} < 500mV @ 1A
- Complementary PNP type: BCX6925
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP capable (Note 4)

Application

- Power MOSFET gate driving
- Low loss power switching

Mechanical Data

- Case: SOT89
- Case Material: molded plastic, "Green" molding compound.
- UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 ⁽³⁾
- Weight: 0.05 grams (Approximate)



Ordering Information (Notes 4 & 5)

Product	Compliance	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
BCX6825TA	AEC-Q101	CD	7	12	1,000
BCX6825QTA	Automotive	CD	7	12	1,000

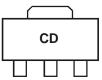
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen and Antimony free, "Green" and Lead-Free.
 Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified.

5. For packaging details, go to our website at http://www.diodes.com.

Marking Information



CD = Product Type Marking Code





BCX6825

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	25	V
Collector-Emitter Voltage	V _{CEO}	20	V
Emitter-Base Voltage	V _{EBO}	5	V
Continuous Collector Current	Ι _C	1	A
Peak Pulse Current	I _{CM}	2	A
Base Current	I _B	100	mA

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector Power Dissipation	PD	1	W
Thermal Resistance, Junction to Ambient Air (Note 6)	R _{0JA}	125	°C/W
Thermal Resistance, Junction to Leads (Note 7)	R _{θJL}	10.01	°C/W
Operating and Storage Temperature Range	T _{J,} T _{STG}	-65 to +150	۵°

ESD Ratings (Note 8)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	≥ 8,000	V	3B
Electrostatic Discharge - Machine Model	ESD MM	≥ 400	V	С

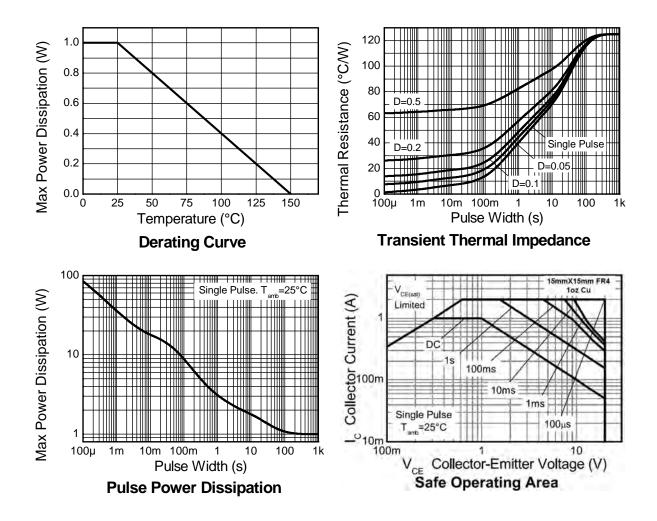
Notes: 6. For a device surface mounted on 15mm X 15mm FR4 PCB with high coverage of single sided 1 oz copper, in still air conditions; device measured when operating in steady state condition.
Thermal resistance from junction to solder-point (on the exposed collector pad).
Refer to JEDEC specification JESD22-A114 and JESD22-A115.







Thermal Characteristics and Derating Information





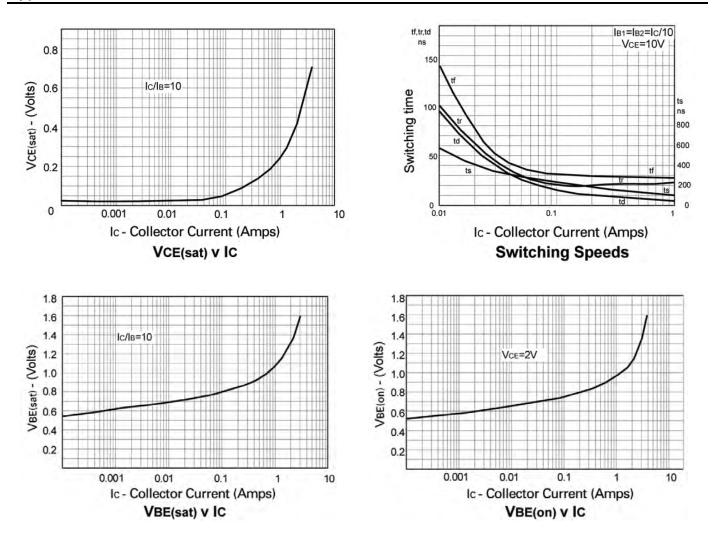


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Characteristic	Symbol	Min	Тур.	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV _{CBO}	25	-	-	V	I _C = 100μA
Collector-Emitter Breakdown Voltage (Note 9)	BV _{CEO}	20	-	-	V	$I_{\rm C} = 10 {\rm mA}$
Emitter-Base Breakdown Voltage	BV _{EBO}	5	-	-	V	I _E = 100μA
Collector Cutoff Current	I _{CBO}	-	-	100 10	nA μA	V _{CB} = 25V V _{CB} = 25V, T _A = +125°C
Emitter Cutoff Current	I _{EBO}	-	-	100	nA	$V_{EB} = 5V$
DC current transfer Static ratio (Note 9)	h _{FE}	50 160 60	- 250 -	400	-	$I_{C} = 5mA, V_{CE} = 10V$ $I_{C} = 500mA, V_{CE} = 1V$ $I_{C} = 1A, V_{CE} = 1V$
Collector-Emitter Saturation Voltage (Note 9)	V _{CE(sat)}	-	-	0.5	V	$I_{\rm C} = 1$ A, $I_{\rm B} = 100$ mA
Base-Emitter Turn-on Voltage (Note 9)	V _{BE(on)}	-	-	1.0	V	$I_{C} = 1A, V_{CE} = 1V$
Transitional Frequency	f _T	100	-	-	MHz	$I_{C} = 100 \text{mA}, V_{CE} = 5 \text{V}, f = 100 \text{MHz}$
Output capacitance	Cobo	-	-	25	pF	V _{CB} = 10V, f = 1MHz

Notes: 9. Measured under pulsed conditions. Pulse width \leq 300µs. Duty cycle \leq 2%.

Typical Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

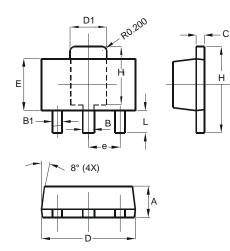






Package Outline Dimensions

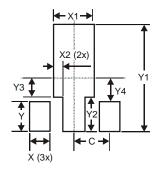
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



	SOT89		
Dim	Min	Max	
Α	1.40	1.60	
В	0.44	0.62	
B1	0.35	0.54	
С	0.35	0.44	
D	4.40	4.60	
D1	1.62	1.83	
Е	2.29	2.60	
е	1.50 Typ		
Н	3.94 4.25		
H1	2.63	2.93	
L	0.89	1.20	
All C	All Dimensions in mm		

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Х	0.900
X1	1.733
X2	0.416
Y	1.300
Y1	4.600
Y2	1.475
Y3	0.950
Y4	1.125
C	1.500





BCX6825

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